



# Low-Resistance Molded Inductor 3.3µH

#### **APPLICATIONS**



- Battery-powered devices
- Embedded computing
- High-current SMPS
- High-frequency SMPS
- POL converters
- FPGA

#### **FEATURES**

- Size 5.5mmx5.3mmx2.9mm
- Low DCR
- Low AC Losses
- Low Audible Noise
- Molded Construction
- Soft Saturation
- Stable Over High Temperatures
- Max Operating Temp +155°C
- RoHS/REACH-Compliant, Halogen-Free

ELECTRICAL CHARACTERISTICS					
Parameter			Value	Unit	
Inductance (1)	L	±20%	3.3	μH	
Resistance	<b>R</b> <sub>DC</sub>	typ	21	mΩ	
Resistance MAX	RDC MAX	max	23.5	mΩ	
Rated Current (2)	<b>I</b> <sub>R</sub>	typ	6.0	Α	
Saturation Current 25°C (3)	ISAT 25°C	typ	10	Α	
Saturation Current 100°C (4)	ISAT 100°C	typ	10	Α	
Resonance Frequency	fr	typ	30	MHz	

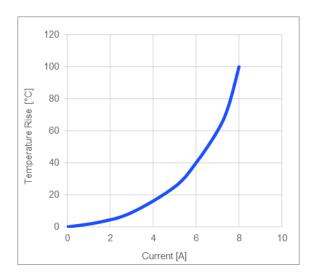
GENERAL SPECIFICATION	IS
(1) Inductance	Measured at 100kHz, 100mA
(2) Rated Current	Rated current will cause the coil temperature rise $\Delta T$ of 40K $I_R$ measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35 $\mu$ m Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.
(3) Saturation Current 25°C	Saturation current will cause L to drop from 30% at 25°C ambient temperature
(4) Saturation Current 100°C	Saturation current will cause L to drop from 30% at 100°C ambient temperature
<b>Temperature Test Condition</b>	Electrical specifications measured at 25°C, 35% RH if not given differently
Operating Condition	Operating temperature: -40°C to +155°C (including temp rise)
	Should not exceed +155°C under worst-case operation conditions
Storage Condition	Tape and Reel packaging: -10°C to +40°C Humidity: <50% RH

All MPS parts are lead-free, halogen-free, and adhere to the RoHS directive. For MPS green status, please visit the MPS website under Quality Assurance. "MPS", the MPS logo, and "Simple, Easy Solutions" are registered trademarks of Monolithic Power Systems, Inc. or its subsidiaries.

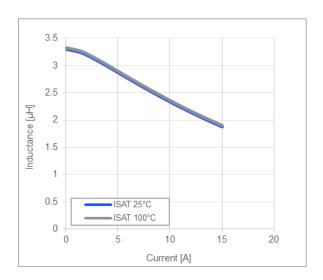


# **TYPICAL PERFORMANCE CURVES**

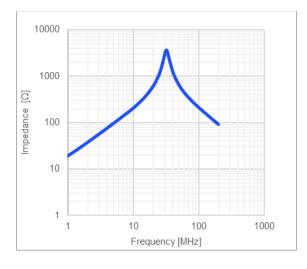
### **Temperature Rise vs. Current**



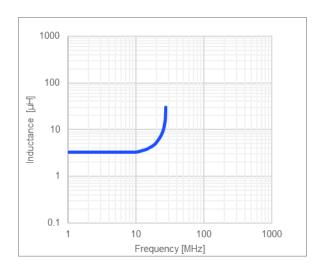
#### **Inductance vs. Current**



Impedance vs. Frequency

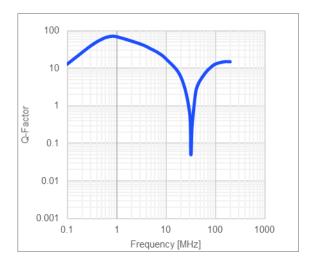


Inductance vs. Frequency

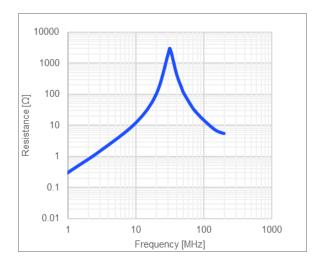




### **Quality Factor vs. Frequency**

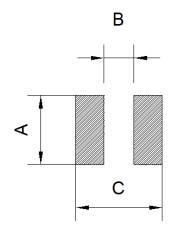


### AC Resistance vs. Frequency





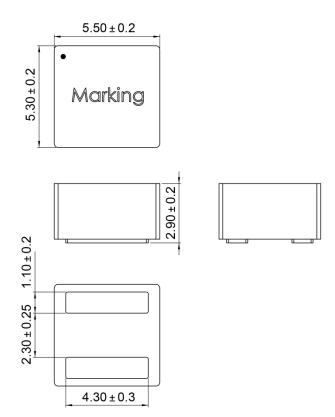
LAND PATTERN			
Dimensions			
Α	4.70 ref.		
В	2.0 ref.		
С	4.50 ref.		
	(unit in mm)		



# PRODUCT PACKAGE AND DIMENSIONS

### **Dimensions**

(unit in mm)



# TOP MARKING Marking Start of Winding · (dot) Inductance Code 3R3 MPS Code MPS



ORDERING INFORMATION					
Part Number	<u>L</u> (1)	RDC	I <sub>R</sub> <sup>(2)</sup>	ISAT 25°C (3)	ISAT 100°C (4)
	typ (µH)	typ (mΩ)	typ (A)	typ (A)	typ (A)
MPL-AL5030-R47	0.47	3.78	13.6	26.5	26.5
MPL-AL5030-R56	0.56	3.92	13.2	22	22
MPL-AL5030-R82	0.82	5.0	12.8	18	18
MPL-AL5030-1R0	1.0	6.5	11.2	16	16
MPL-AL5030-1R2	1.2	8.0	10.0	14	14
MPL-AL5030-1R5	1.5	9.7	9.0	12.5	12.5
MPL-AL5030-1R8	1.8	10.5	8.8	12	12
MPL-AL5030-2R2	2.2	12.3	8.2	11	11
MPL-AL5030-3R3	3.3	21	6.0	10	10
MPL-AL5030-4R7	4.7	33	5.3	8	8

GENERAL SPECIFICATIONS		
Measured at 100kHz, 100mA		
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Saturation current will cause L to drop from 30% at 25°C ambient temperature		
Saturation current will cause L to drop from 30% at 100°C ambient temperature		
Electrical specifications measured at 25°C, 35% RH if not given differently		
Operating temperature: -40°C to +155°C (including temp rise)		
Should not exceed +155°C under worst-case operation conditions		
Tape and Reel packaging: -10°C to +40°C		
Humidity: <50% RH		

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